### DATA SHEET



# SILICON POWER TRANSISTOR 2SA1650

# PNP SILICON EPITAXIAL TRANSISTOR FOR HIGH-SPEED SWITCHING

The 2SA1650 is a mold power transistor developed for highspeed switching and features a very low collector-to-emitter saturation. This transistor is ideal for use in switching power supplies, DC/DC converters, motor drivers, solenoid drivers, and other low-voltage power supply devices, as well as for high-current switching.

#### **FEATURES**

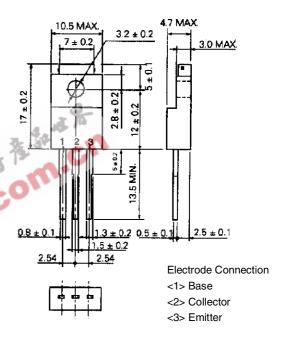
- Mold package that does not require an insulating board or insulation bushing
- · Fast switching speed
- Low collector-to-emitter saturation voltage:  $V_{CE(sat)} \leq -0.3~V~(MAX.)~@Ic = -3~A$

#### **QUALITY GRADES**

Standard

Please refer to "Quality Grades on NEC Semiconductor Devices" (Document No. C11531E) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

#### PACKAGE DRAWING (UNIT: mm)



#### ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Conditions	Ratings	Unit
Collector to base voltage	Vсво		-150	٧
Collector to emitter voltage	Vceo		-100	٧
Emitter to base voltage	VEBO		-7.0	٧
Collector current	I <sub>D(DC)</sub>		-5.0	Α
Collector current	IC(pulse)	PW ≤ 300 μs, duty cycle ≤ 10%	-10	Α
Base current	I <sub>B(DC)</sub>		-2.5	Α
Total power dissipation	Рт	Tc = 25°C	25	W
Total power dissipation	PT	Ta = 25°C	2.0	W
Junction temperature	Tj		150	°C
Storage temperature	T <sub>stg</sub>		-55 to +150	°C

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## **ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

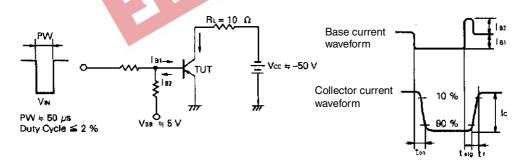
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit			
Collector cutoff current	Ісво	V <sub>CB</sub> = -100 V, I <sub>E</sub> = 0			-10	μΑ			
Emitter cutoff current	ІЕВО	V <sub>EB</sub> = -5 V, I <sub>C</sub> = 0			-10	μΑ			
DC current gain	h <sub>FE1</sub> *	Vce = -2 V, Ic = -0.5 A	100			-			
DC current gain	hFE2*	Vce = -2 V, Ic = -1 A	100		400	-			
DC current gain	h <sub>FE3</sub> *	$V_{CE} = -2 \text{ V}, \text{ Ic} = -3 \text{ A}$	60			-			
Collector saturation voltag	VCE(sat)1*	Ic = -3 A, I <sub>B</sub> = -0.15 A			-0.3	٧			
Collector saturation voltag	VCE(sat)2*	Ic = -4 A, IB = -0.2 A			-0.5	٧			
Base saturation voltage	V <sub>BE(sat)1</sub> *	Ic = -3 A, I <sub>B</sub> = -0.15 A			-1.2	٧			
Base saturation voltage	V <sub>BE(sat)2</sub> *	Ic = -4 A, IB = -0.2 A			-1.5	٧			
Gain bandwidth product	f⊤	Vce = -10 V, Ic = -0.5 A		150		MHz			
Collector capacitance	Cob	V <sub>CB</sub> = -10 V, I <sub>E</sub> = 0, f = 1 MHz		130		pF			
Turn-on time	ton	$I_C = -3 A$ , $I_{B1} = -I_{B2} = -0.15 A$ ,		0.3		μs			
Storage time	tstg	R <sub>L</sub> = 10 $\Omega$ , Vcc = -50 V Refer to the test circuit.	.0	1.5		μs			
Fall time	tf	neighto the test chedit.	. A. Th	0.4		μs			
Fall time $t_f$ Refer to the test circuit. $0.4$ $\mu s$ * Pulse test PW $\leq 350$ $\mu s$ , duty cycle $\leq 2\%$ <b>hre CLASSIFICATION</b>									
Marking M		L K							
h <sub>FE2</sub> 100 to 2	00 1	50 to 300 200 to 400							
<u> </u>									

<sup>\*</sup> Pulse test PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2%

#### **hfe CLASSIFICATION**

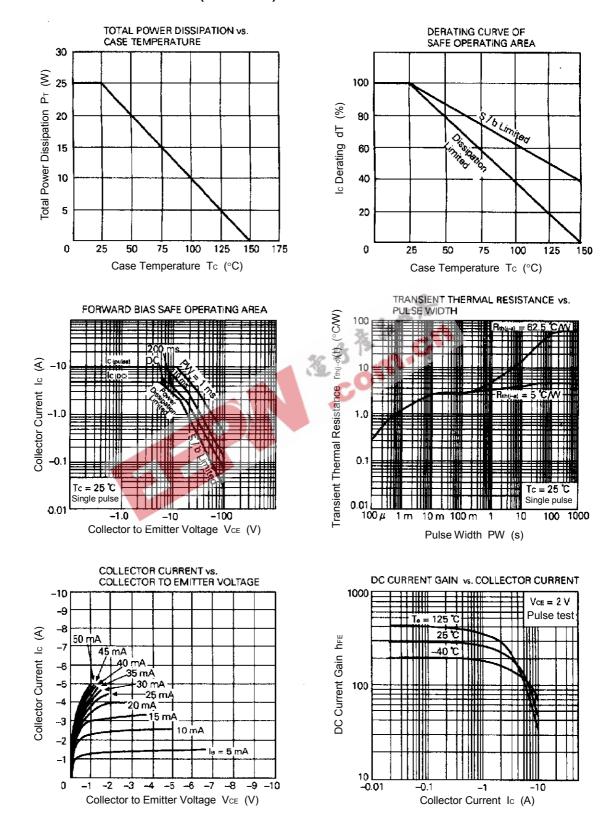
Marking	М	L	1	K	
h <sub>FE2</sub>	100 to 200	150 to 300		200 to 400	

# SWITCHING TIME TEST CIRCUIT



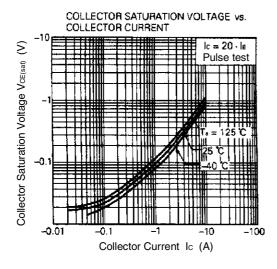


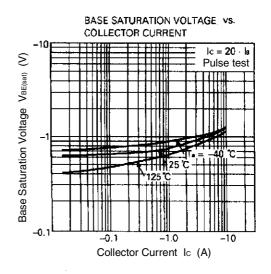
#### TYPICAL CHARACTERISTICS (Ta = 25°C)

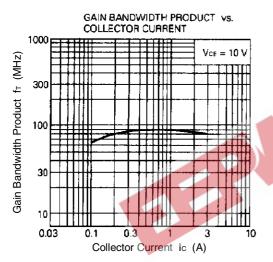


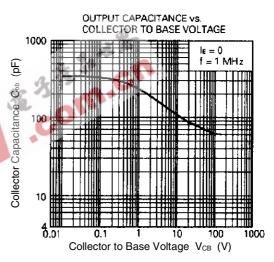
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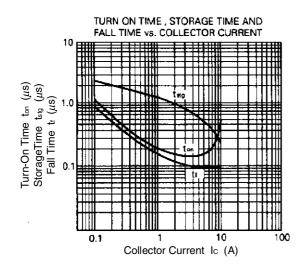
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